

JEDEC	TITLE 244 PIN DDR2/DDR3 MINI DIMI	ISSUE	DATE		SHEET
SOLID STATE PRODUCT OUTLINE	244 PIN DDR2/DDR3 MINI DIMI 0.60 mm LEAD CENTERS	C	FEB 2008	MO-244	2 OF 7

	COMMON DIMENSION TABLE				
SYMBOL	MIN	NOM	MAX	NOTES	
A1		6.00 BASIC			
A2	4.00			5.8	
A3		20.00 BASIC			
Α4		10.00 BASIC			
D	81.85	82.00	82.15		
D1		39.60 BASIC			
D2					
e1		38.40 BASIC			
e2		33.60 BASIC			
N		244			
ISSUE	А				
REF	14-057				
NOTES	1,2,3				

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PRODUCT OUTLINE	0.60 mm LEAD CENTERS		2008		

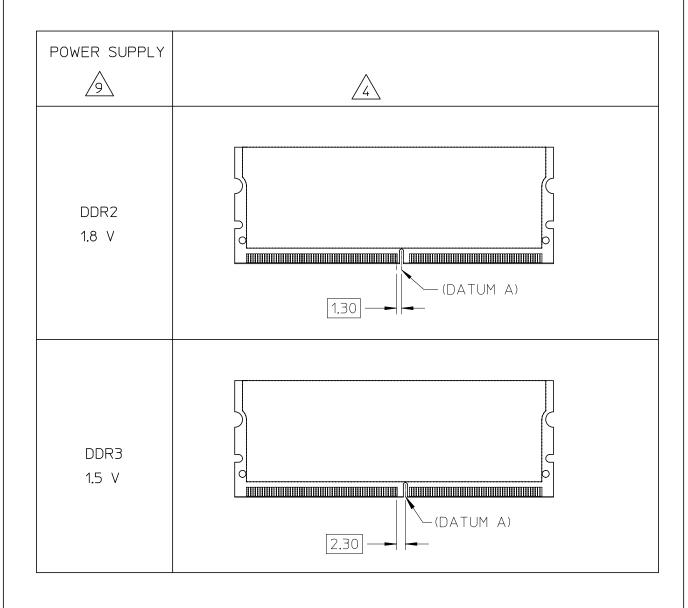
VARIATIONS										
		АА			AB					
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX	NOTES			
А	29.85	30.00	30.15	29.85	30.00	30.15				
D3	1.30 BASIC			2.30 BASIC			4			
D4	1.30 BASIC			2.30 BASIC						
D5		1.90 BASK	_	2	2.90 BASIC	-				
E			3.80			3.80	5			
ISSUE	А	A								
REF	14-057	14-057								
NOTES	1,2,3									

	VARIATIONS									
		ВА			BB					
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX	NOTES			
А	29.85	30.00	30.15	29.85	30.00	30.15				
D3	1.30 BASIC			2.30 BASIC			4			
D4	1.30 BASIC			2.30 BASIC						
D5		1.90 BASK	-	2.90 BASIC						
Е			6.45			6.45	5			
ISSUE	В	В								
REF	14-072	14-072								
NOTES	1,2,3									

	VARIATIONS									
		CA			CB					
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX	NOTES			
А	29.85	30.00	30.15	29.85	30.00	30.15				
D3	1.30 BASIC			2.30 BASIC			4			
D4	1.30 BASIC			2.30 BASIC						
D5		1.90 BASI	- -	2.90 BASIC						
Е			7.25			7.25	5			
ISSUE	В	В								
REF	14-072	14-072								
NOTES	1,2,3									

JEDEC	TITLE	DIVI DDD3/DDD3 MINII DIMM	ISSUE	DATE		SHEET
SOLID STATE PRODUCT OUTLINE	244 0.6	PIN DDR2/DDR3 MINI DIMM 00 mm LEAD CENTERS	С	FEB 2008	M0-244	4 OF 7

# MECHANICAL KEYING (FRONT VIEWS)



JEDEC T	TITLE	ISSUE	DATE		SHEET	
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#### NOTES:

- 1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. TOLERANCES ON ALL DIMENSIONS ±0.15 UNLESS OTHERWISE SPECIFIED.
- 3. ALL DIMENSIONS ARE MM.



## APPLICATION NOTE:

VARYING THE POSITION OF THE NOTCH IDENTIFIES THE OPERATIONAL VOLTAGE: 1.8 VOLT (xA). 1.5 VOLT (xB).



DIMENSIONS APPLICABLE WHEN COMPONENTS MOUNTED ON BOTH SIDES.



CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALIZATION.



## APPLICATION NOTE:

RECOMMENDED PLATING FOR CONTACT PADS ARE;

- 1) PREFERABLE PLATING: ELECTROLYTIC GOLD PLATING 0.76 MICROMETERS MINIMUM OVER ELECTROLYTIC NI 2.00 MICROMETERS MINIMUM.
- 2) ALTERNATIVE PLATING: GOLD PLATING 0.05-0.75 MICROMETERS OVER NI 2.00 MICROMETERS MINIMUM MUST USE AN ELECTRONIC CONTACT GRADE CORROSIVE BARRIER LUBRICANT.



BORDER OF COMPONENT AREA.



THE JC-45 COMMITTEE CONTROLS THE INFORMATION IN THIS COLUMN. IT IS SHOWN HERE FOR REFERENCE ONLY, AND IS SUBJECTED TO CHANGE.



#### 10\ APPLICATION NOTE :

EDGE OF CONTACT PADS SHALL BE FREE OF BURRS AND EXTERNAL TIE BARS.



 $^{\prime}$ 11 $^{\setminus}$  THE ADDITION OF THIS BEVEL IS A FABRICATION OPTION AND IS NOT REQUIRED. THE BEVEL AIDS THE INSERTION OF THE MODULE INTO THE CONNECTOR. THE BEVEL IS NOT TO HIT THE PLATED CONTACTS.



## PATENT CLAIM:

IT HAS BEEN STATED THAT U.S. PATENT NO. 5,227,664 (HELD BY HITACHI) MAY BE RELATED TO CERTAIN IMPLEMENTATIONS OF THIS PACKAGE OUTLINE.

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# Change Record

If the changes involves any words added or deleted ( excluding deletion of accidentally repeated words ), the change is included. Punctuation changes may or may not be included.

Initial Issue : A	Date :	APRIL 2004	Item : JC11.14-057
		Revision History	
Issue : B	Date : D	ECEMBER 2004	Item : JC11.14-072 & 14-075
Location :		Change from :	Change to :
PAGE 2		1.00±0.05	1.00±0.10
PAGE 2		NEW HEIGHT VARIATIONS	BA, BB, CA. CB

Issue : C Date :	FEBRUARY 2008	Item : JC11.14-121
Location :	Change from :	Change to :
PAGE 1	NEW POSITIONAL TOLERANCE	⊕ 0.10 M C B A
PAGE 1	EDIT GD&T CONTROL FRAMES	REMOVE DIAMETER SYMBOLS
PAGE 1	NEW TEXT	"(OPTIONAL NOTCH)"
PAGE 1	<b>⊕</b> Ø 0.10 <b>()</b> C  <b>B</b>  A	⊕ 0.10 M C B
PAGE 2	CHAMFER 0.25/0.05	CHAMFER 0.35/0.05
PAGE 2	EDIT GD&T CONTROL FRAME	COMPOSITE TOLERANCE
PAGE 5	DEFINE DDR2 VOLTAGE KEY	DDR2 & 1.8 V
PAGE 5	DEFINE DDR3 VOLTAGE KEY	DDR3 & 1.5 V
PAGE 6 (NOTE 9)	JC-42.5	JC-45
PAGE 7	NEW PAGE	ADDED CHANGE RECORD PAGE
PAGES 1 TO 7	REVISED TITLE	INCLUDE TEXT "DDR3"

Issue:	Date :		Item :
Location :		Change from :	Change to :

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